

Direct Growth of Continuous and Uniform MoS₂ Film on SiO₂/Si Substrate Catalyzed by Sodium Sulfate

Guanmeng Li, Xiaoli Wang, Bo Han, Weifeng Zhang, Shuyan Qi, Yan Zhang, Jiakang Qiu, Peng Gao, Shaoshi Guo, Run Long, Zhenquan Tan,* Xue-Zhi Song,* and Nan Liu*

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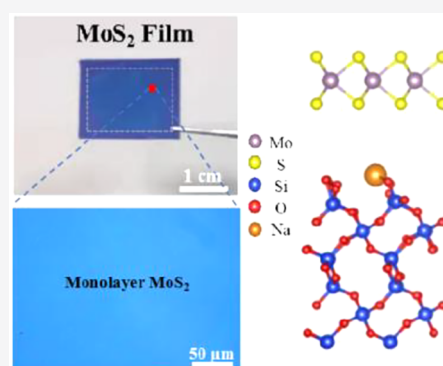
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ABSTRACT: Because of its unique electronic band structure, molybdenum disulfide (MoS₂) has been regarded as a star semiconducting material. However, direct growth of continuous and high-quality MoS₂ films on SiO₂/Si substrates is still very challenging. Here, we report a facile chemical vapor deposition (CVD) method based on synergistic modulation of precursor and Na₂SO₄ catalysis, realizing the centimeter scale growth of a continuous MoS₂ film on SiO₂/Si substrates. The as-grown MoS₂ film had an excellent spatial homogeneity and crystal quality, with an edge length of the composite domain as large as 632 μm. Both experimental and theoretical results proved that Na tended to bond with SiO₂ substrates rather than to interfere with as-grown MoS₂. Thus, they showed decent and uniform electrical performance, with electron mobilities as high as 5.9 cm² V⁻¹ s⁻¹. We believe our method will pave a new way for MoS₂ toward real application in modern electronics.



Two-dimensional layered transition-metal dichalcogenide (TMD) materials have been widely explored as the most promising replacements for Si,^{1–3} and molybdenum disulfide (MoS₂) with a band gap of 1.2–1.9 eV and a thickness scaling feature is a representative example.^{4–7} MoS₂ has unique electrical and optoelectrical properties, including high light absorption, large excitonic effect, band gap modulation, strong piezoelectricity, and so on. It has wide prospective uses in the applications of well-controlled electrostatics in ultrashort transistors,^{8,9} ultrasensitive optoelectrical devices,^{10,11} and piezoelectrical sensors.¹² The prerequisite of all the above-mentioned advanced electronic and optoelectronic applications is large-scale growth of high-quality and continuous MoS₂ thin films. Thus, developing a reliable and scalable synthetic method for MoS₂ film is highly desired.^{13–16}

Researchers have devoted extensive efforts to growing large-area and continuous MoS₂ films, such as conventional chemical vapor deposition,¹⁷ metal–organic chemical vapor deposition (MOCVD),^{18–20} physical vapor deposition (PVD),^{21,22} atomic layer deposition (ALD),²³ and thermal deposition.^{24,25} Among them, MOCVD is able to achieve high-quality MoS₂ films with average electron mobility of 30 cm² V⁻¹ s⁻¹ at room temperature. However, it requires very expensive equipment and may introduce carbon-based contaminations from organic compounds during the reaction, where device performance may deteriorate.¹⁴ Although PVD and ALD are less expensive than MOCVD, they can achieve only low-quality MoS₂ films with very small grain size and low carrier mobility, which cannot be used for real applications in high-speed electronic devices. Conventional CVD growth of MoS₂ films is most

widely explored because of its low cost as well as scalable production. To improve the crystallinity of MoS₂ films, hydrogen,²⁶ oxygen, or other harsh conditions are specifically introduced,^{15,18} but they may lead to potential safety hazards in practical applications. For example, Yang et al. successfully synthesized uniform monolayer MoS₂ film with large domain size on solid soda-lime glass by introducing a rush of O₂.¹⁵ Recently, it has been observed that the addition of selected synergistic additives to the CVD substrates, such as alkali metal halides,^{27–31} KOH,³² fluorides,³³ and seed catalysts can result in exponential increase of growth area for 2D materials.^{34,35} Liu's group reported that NaCl-mediated CVD can be widely used in the synthesis of various 2D TMDs and accomplish the growth of millimeter-scale MoS₂ single crystal.²⁸ However, all the above catalyst-mediated growth of continuous MoS₂ films happen on sapphire, mica, and glass,^{31,36} which are not compatible with Si-based technology. Therefore, there still remains a big challenge in attaining MoS₂ film being large-area, continuous and high-quality at the same time, in particular directly on SiO₂/Si substrates.

Herein, we report a precursor and catalyst co-mediated method for fabrication of centimeter-scale, continuous, and high-quality MoS₂ films directly on SiO₂/Si substrates. This method demonstrated the growth of a large-area MoS₂ film

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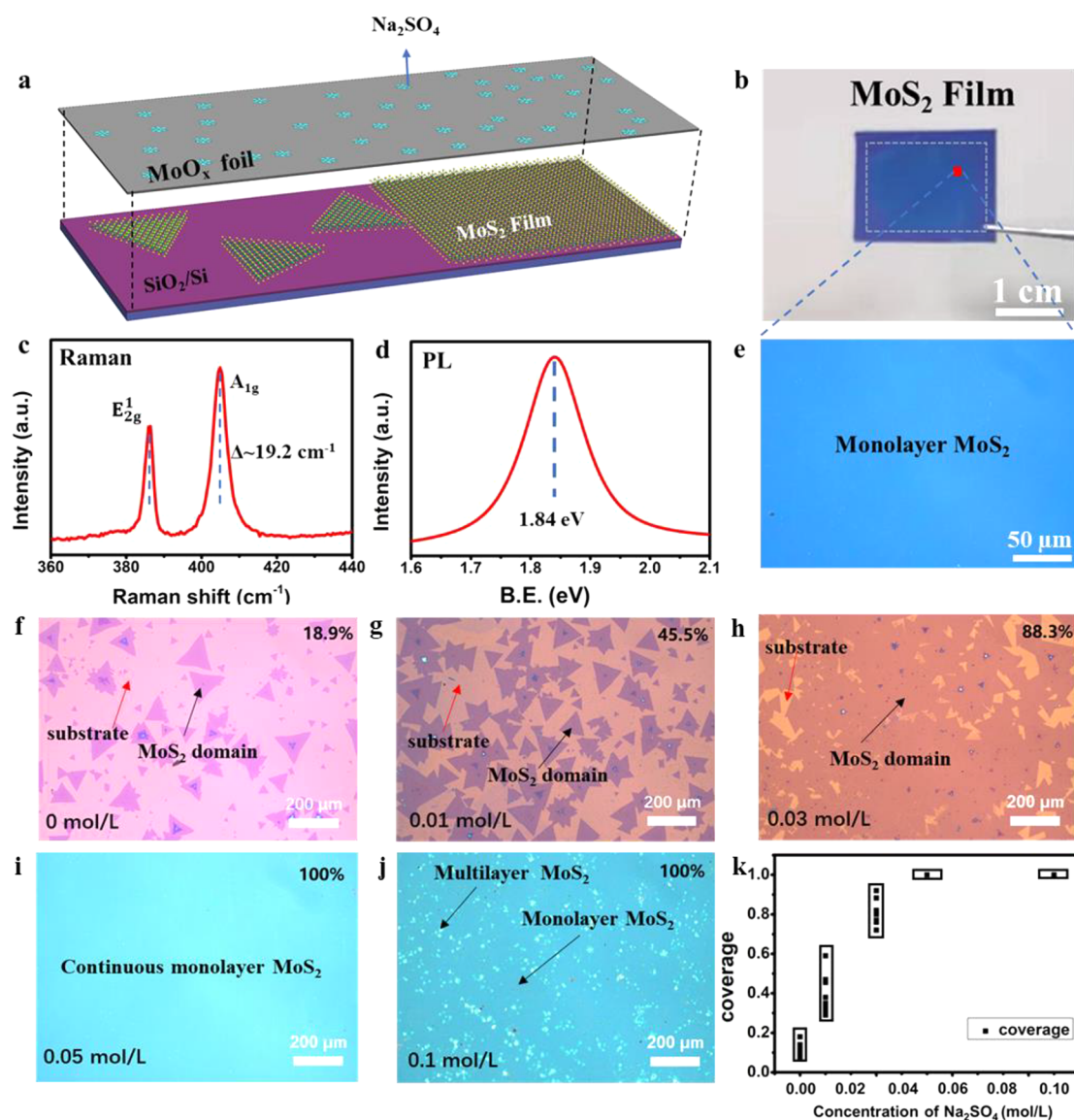


Figure 1. Centimeter-scale growth of MoS₂ film. (a) Schematic diagram of face-to-face growth of MoS₂ film. Top: MoO_x foil as precursor and Na₂SO₄ as catalysts. Bottom: as-grown MoS₂ film on SiO₂/Si substrate. (b) Photograph of centimeter-scale MoS₂ film on SiO₂/Si promoted by 0.05 mol/L Na₂SO₄. (c and d) Raman and photoluminescence spectra of as-grown monolayer MoS₂ in panel b. (e) Optical image of uniform and continuous MoS₂ film taken from panel b. (f) Optical image of sporadic MoS₂ domains on SiO₂/Si substrate without the promotion of Na₂SO₄. (g–j) Optical images of MoS₂ domains/films on SiO₂/Si substrate with the promotion of Na₂SO₄ (0.01, 0.03, 0.05, and 0.1 mol/L). (k) Statistical chart of coverage of MoS₂ as a function of Na₂SO₄ concentration.

with the composite domains possessing an edge length as large as 632 μm on the SiO₂/Si substrate. This immediately allowed us to fabricate FET arrays with standard photolithography rather than relying on complicated electron beam lithography (EBL) to selectively design contact electrodes on randomly small domains. They showed a maximum carrier mobility of 5.9 cm² V⁻¹ s⁻¹ and an on/off current ratio of ~10⁵–10⁶ at room temperature, which was comparable to those grown by many methods.^{15,24,25,29} We propose a synergistic mechanism in which precursor regulation and Na₂SO₄ catalysis co-contributed to large-area growth of MoS₂ film. The introduction of MoO_x foil as precursor provided a face-to-face growth fashion as well as higher reactive activity than Mo foil. When using Na₂SO₄ as a synergetic additive, not only did the overall reaction rate increase, but also Na atoms tended to bond with SiO₂ substrates rather than to interfere with as-grown MoS₂ based on density functional theory (DFT)

calculation and X-ray photoelectron spectroscopy (XPS) study, resulting in high-quality MoS₂ film. This work paves the way to the batch production of high-uniformity and -quality MoS₂ films, which will advance its practical applications in various fields.

Figure 1a schematically illustrates our face-to-face growth process, in which MoO_x foil with the Na₂SO₄ synergistic additive is placed on top of the SiO₂/Si substrate. MoO_x foil with higher chemical activity was chosen as precursor. Na₂SO₄ as synergistic additive was uniformly distributed throughout the foil. The whole reaction was conducted with argon as the only carrier gas without introducing flammable and explosive gases such as hydrogen and oxygen, which ensures the security of large-scale production (see details in Experimental Methods and Figure S1 in the Supporting Information). Figure 1b shows a representative result of the as-grown MoS₂ film on the SiO₂/Si substrate circled by a white dashed line. The film was

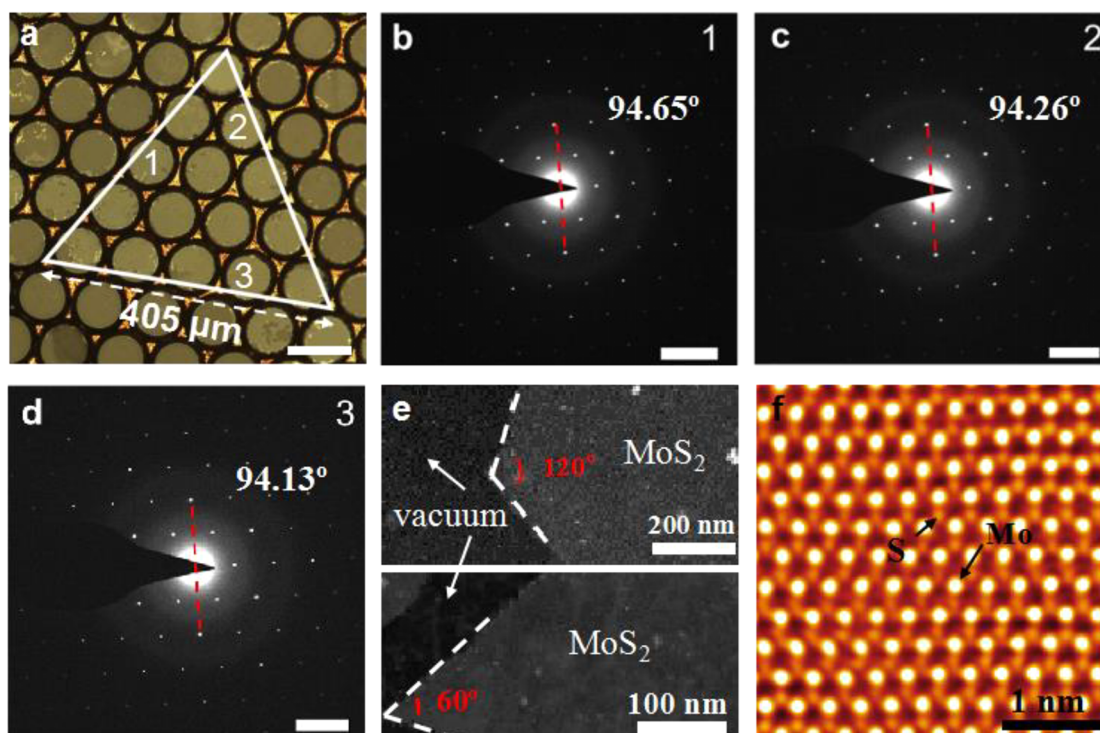


Figure 2. Atomically resolved TEM measurements of MoS₂. (a) Optical image of MoS₂ transferred onto a TEM grid (scale bar: 100 μm). (b–d) SAED patterns from the regions numbered 1–3 in panel a. The dashed lines indicate the rotation angles (94.65°, 94.26°, 94.13°) with respect to the horizontal line (scale bar: 5 nm⁻¹). (e) STEM image of monolayer MoS₂ edge ended with specific edge angles (60° or 120°). (f) Inverse FFT image of monolayer MoS₂. The bright and dim spots correspond to Mo and S atoms, respectively.

centimeter-scale and could be further scalable by increasing the size of the growth chamber. From its magnified optical microscopy (OM) image, a highly uniform color contrast was clearly seen, indicating the uniform thickness and in-plane continuity of the MoS₂ film (Figure 1e). The large MoS₂ crystal domain could be distinguished with an edge length as large as 632 μm encircled by a number of hexagonal contour traces of epitaxial growth (Figure S2a). Then, the layer number and crystal quality of the MoS₂ film were evaluated by Raman and photoluminescence (PL) spectra. The main Raman modes of E_{2g}¹ and A_{1g} were observed at ~386.1 and ~405.3 cm⁻¹, corresponding to the intralayer vibrations along the in-plane or out-of-plane directions, respectively, with peak frequency difference of ~19.2 cm⁻¹. The small peak frequency difference is evidence of monolayer MoS₂ (Figure 1c).³⁷ In the PL spectrum (Figure 1d), the presence of a sharp peak positioned at 1.84 eV with high intensity further revealed the MoS₂ monolayer was of high quality.²⁶

In order to investigate the effect of Na₂SO₄ additive on the growth result, different concentrations of Na₂SO₄ were applied on MoO_x foil (Figure 1f–j). Without the Na₂SO₄ additive, sporadic MoS₂ domains were observed on the SiO₂/Si surface. With the concentration of Na₂SO₄ increased, MoS₂ domain size significantly increased. At the concentration of 0.05 mol/L, MoS₂ domains stitched into one film and almost fully covered the SiO₂/Si surface. When the concentration of Na₂SO₄ further increased (*c* = 0.1 mol/L), multilayer MoS₂ began to appear, indicating a turning point from island growth mode to layer-by-layer mode (Figures 1j and S2b). Thus, in our specific growth environment, 0.05 mol/L Na₂SO₄ was an optimal concentration to achieve uniform and continuous monolayer MoS₂ film. The disappearance of nucleating points at this

concentration of Na₂SO₄ was due to the balance of growth rate and mass flux of metal precursor.²⁸ Statistical analysis of coverage of MoS₂ as a function of Na₂SO₄ concentration also proved that Na₂SO₄ was indeed a promoter on the growth of MoS₂ in terms of growth rate and film coverage (Figure 1k).

Transmission electron microscopy (TEM) and scanning transmission electron microscopy (STEM) were used to probe the microstructure of the continuous MoS₂ film. Figure 2a is an optical image of a typical triangular MoS₂ domain with an edge length of ~405 μm on a TEM grid. We carried out a series of selective area electron diffraction (SAED) measurements on different locations to identify whether the domain is a single crystal (Figure 2a–d). All of the diffraction spots showed strong hexagonal patterns with almost identical lattice orientations (deviation smaller than ±0.52°) (Figure 2b–d), suggesting the single-crystal nature and uniformity across a large area. We also performed atomic-resolution observation by high-angle annular dark field scanning transmission electron microscopy (HAADF-STEM) equipped with aberration-corrected TEM. Over the imaging areas of Figures 2e and S3a–c, MoS₂ was uniform and tended to end with specific edge angles (60° or 120°). It was clearly distinguished that Mo and S atoms were arranged in hexagonal symmetry as highlighted by bright and dim balls in the STEM image and corresponding filtered image using inverse fast Fourier transform (FFT) (Figures S3d and 2f), consistent with the micro-characteristics of MoS₂. Overall, on the basis of the atomic-resolution TEM study, we concluded that the as-grown MoS₂ film is of high uniformity and crystallinity at the atomic scale.

Uniformity of the thin film is an important evaluation criterion in the semiconductor industry. To ensure structural

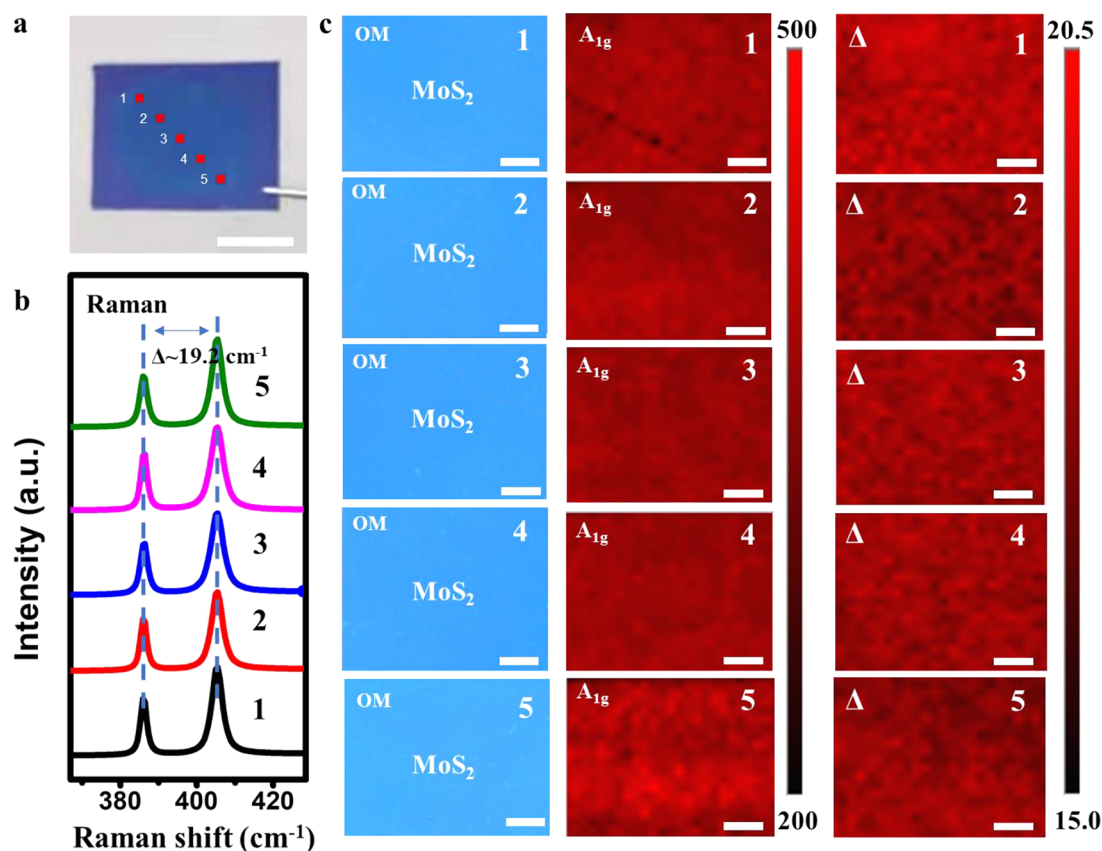


Figure 3. Uniformity of the centimeter-scale MoS₂ film. (a) Photograph of as-grown MoS₂ film on SiO₂/Si (scale bar: 1 cm). (b) Raman spectra of the designated regions, which were labeled as 1–5 in panel a. (c) Mapping analysis of the numbered regions (1–5). The corresponding optical images are shown in the left column, Raman mappings of the intensity of A_{1g} in the middle column, and Raman mappings of peak position differences (Δ) between A_{1g} and E_{2g}¹ in the right column (scale bar: 10 μ m).

and electrical uniformity of all the devices on the SiO₂/Si chip, as-prepared thin films are required to be homogeneous over the entire substrate. In order to confirm the large-area uniformity of the MoS₂ film grown by our method, we sequentially selected five regions along the diagonal of the film (Figure 3a) and carried out morphology observation and structure analysis by Raman spectra, optical microscopy, and Raman and PL mappings (Figures 3b,c and S4). As shown in Figure 3b, representative Raman spectra at these regions were nearly identical, showing characteristic features of monolayer MoS₂ with a Δ value (peak position differences between A_{1g} and E_{2g}¹) of 19.2 cm⁻¹. Mapping results over the designated regions also confirmed the film was monolayer, where both distributions of intensities of A_{1g} mode and Δ value were highly uniform. In addition, PL spectra and mapping at these regions were also uniform in both peak position (a single peak of \sim 1.84 eV) and intensity (Figure S4), which was additional evidence of high-quality monolayer MoS₂. Corresponding optical images demonstrated that they were continuous at these locations. Therefore, considering the morphology observation and structure analysis, the as-grown MoS₂ films were continuous and uniform at the centimeter scale.

We next investigated the electrical uniformity of as-grown MoS₂ films by fabricating field effect transistor arrays. Compared to randomly distributed MoS₂ triangle domains which were normally achieved by the CVD method, the device fabrication process was dramatically simplified on as-obtained continuous MoS₂ film. Rather than using complicated and time-consuming EBL to define contact electrodes on selective

MoS₂ domains, we simply patterned Cr/Au as top contact electrodes by photolithography with 300 nm SiO₂ as the dielectric layer and highly doped Si as the back gate (Figure S5a). Figure 4a is a photo of 8 \times 8 MoS₂ FET arrays, where channel length (L) and width (W) were \sim 8.5 μ m and \sim 50 μ m, respectively, and yields of them were about 90%. Panels c and d of Figure 4 are representative output and transfer curves, showing a typical n-type behavior with an electron mobility of 0.88 cm² V⁻¹ s⁻¹ and on/off current ratio of $>10^6$. Carrier mobility can be calculated from the linear regime of the transfer characteristics.^{32,38,39} Based on the statistics of 100 MoS₂ FETs, the mobility value fell in a range of 0.6–5.9 cm² V⁻¹ s⁻¹ with normal distribution. The average electron mobility of as-grown MoS₂ films was about 2.4 cm² V⁻¹ s⁻¹, and the maximum value can reach as high as 5.9 cm² V⁻¹ s⁻¹ (Figures 4d and S5b,c). The on/off ratio fell in the range of 1×10^5 to 1.6×10^6 (Figure S5d). These results confirmed that the as-grown MoS₂ film possessed spatial homogeneity in electrical performance over centimeter areas. Furthermore, the maximum mobility of as-obtained continuous monolayer MoS₂ film was comparable to those of samples grown by many methods,^{15,24,25,29} suggesting that MoS₂ film synthesized in this work has great potential in large-area device fabrication.

We attribute the formation mechanism of high-quality and continuous MoS₂ film to the synergistic modulating of precursor and promoter. First, we compared electrochemically oxidized and nonoxidized Mo foil as precursors to grow MoS₂. As shown in Figure 5a, at the same growth conditions (temperature, growth time, carrier air, Na₂SO₄ additive, etc.),

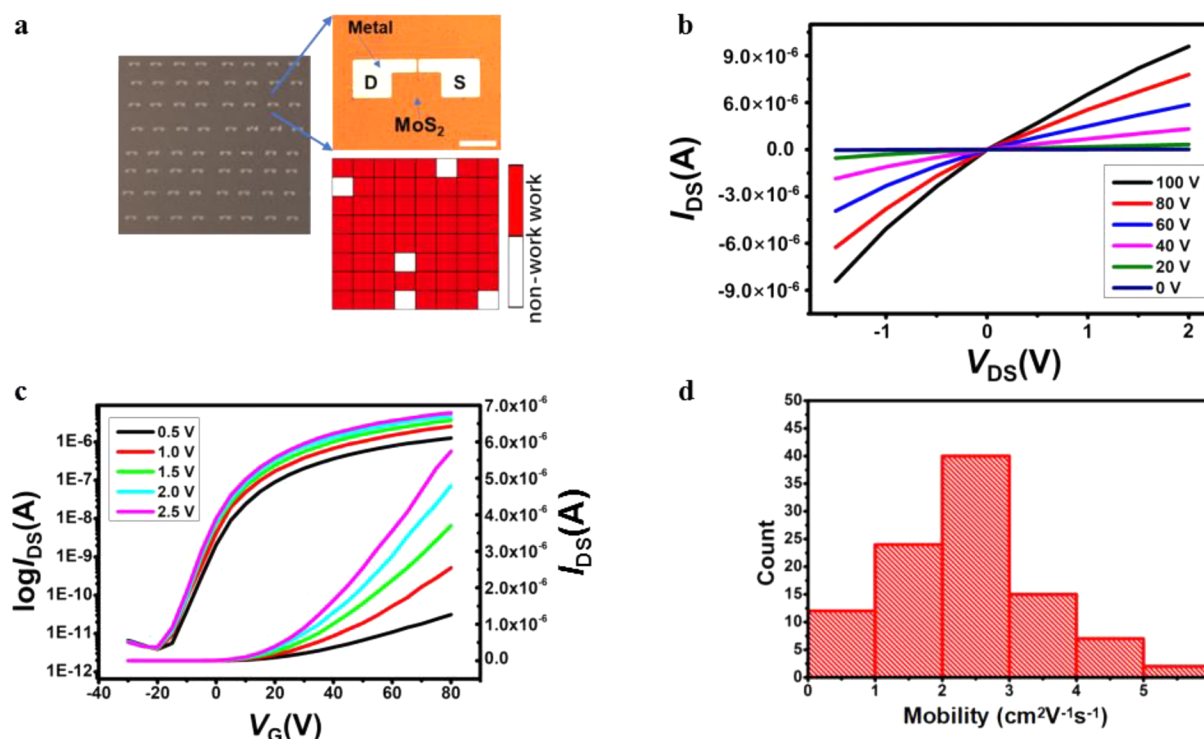
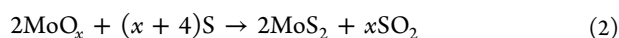


Figure 4. Electrical performance of uniform and continuous MoS₂ film. (a) Photo of 8 × 8 MoS₂ FET arrays fabricated on 1 × 1 cm² SiO₂/Si substrate. Top inset: a zoomed-in view of the optical image on an individual FET with channel length and width of 8.5 and 50 μm (scale bar: 100 μm). Bottom inset: corresponding success rate of FET arrays. Red and white represent working and nonworking devices, respectively. (b and c) Output (b) and transfer (c) characteristics for a typical MoS₂ FET. (d) Distribution of mobilities of 100 FETs.

using Mo foil as precursor we could obtain only randomly distributed MoS₂ domains. If there was no Na₂SO₄ additive, nothing would be grown by the Mo foil as precursor (Figure 5b). In contrast, MoO_x foil as precursor easily led to continuous MoS₂ film on SiO₂/Si (Figure 1i). The following chemical reactions can be used to understand this phenomenon:

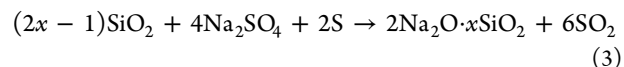


With Mo foil as precursor, an oxidized procedure with oxygen was required, which would decrease the reaction speed and increase the complexity of reaction systems.

Second, we conducted a series of theoretical calculations and experiments to understand the role of Na₂SO₄. Previous work has indicated that the introduction of alkali metal halides is helpful for the CVD growth of 2D materials. NaCl decreases the melting point of the reactants and facilitates the formation of intermediate products, increasing the overall reaction rate.^{27–31} In this work, Na₂SO₄ was used as a synergistic additive instead of alkali metal halides such as NaCl and NaF. This is because the sulfate ion does not introduce heteroatoms into the system, and at high temperature, sulfate ions are decomposed into SO₂ gas, avoiding the contamination of as-grown MoS₂. For example, NaF as synergistic additive would leave contamination on the surface of the MoS₂ film (Figure S6). In contrast, Na₂SO₄ as additive led to a clean surface of the MoS₂ film (Figure 1i).

We considered four Na-MoS₂/SiO₂ systems, including the Na atom adsorbed on the upper and lower surface of MoS₂, on the midperpendicular plane of the MoS₂/SiO₂ interface, and on the topmost layer of the SiO₂ (Figure 5d). The DFT-

calculated total energies showed that the presence of Na atoms between monolayer MoS₂ and SiO₂ substrate led to a lower system energy compared with that of the adsorbed Na atoms on the upper surface of MoS₂. It was worth noting that whether the Na atom is close to MoS₂ or SiO₂ substrate, or at precisely the middle of MoS₂ and SiO₂, the most stable structure is that in which the Na atoms bonded with the O atoms of the SiO₂ substrate. In addition, only small-area MoS₂ could be grown on the Si substrate, indicating that SiO₂ was involved in the reaction (Figure 5c). The chemical reaction between Na and the system of monolayer MoS₂/SiO₂ should be the following:



These all suggested that Na tended to bond with SiO₂ substrates rather than to interfere with as-grown MoS₂, which will result in high-quality MoS₂.

To elucidate that Na as a promoter solely interacted with SiO₂ substrate, XPS was performed to probe the bonding information on as-grown and transferred MoS₂ on SiO₂/Si (Figure 5e–g). For as-grown MoS₂ on SiO₂/Si, XPS spectra of Mo 3d, S 2s, and S 2p were consistent with the that reported in the literature for MoS₂ single crystal,³⁰ and the ratio of Mo to S is 1:2, further confirming the high quality of our MoS₂ film (Figures 5e and S7). XPS spectra of Na 2p, Na 2s, and Na 1s also indicated the formation of Na₂O (Figure 5f,g). After MoS₂ was transferred onto a second SiO₂/Si substrate, there was no Na signal any more (Figure 5f,g). Meanwhile, after transfer, on the as-grown SiO₂/Si substrate, the Na peak still existed without any MoS₂ trace (Figure S8). These results indicated that Na only reacted with SiO₂/Si substrate, and it does not

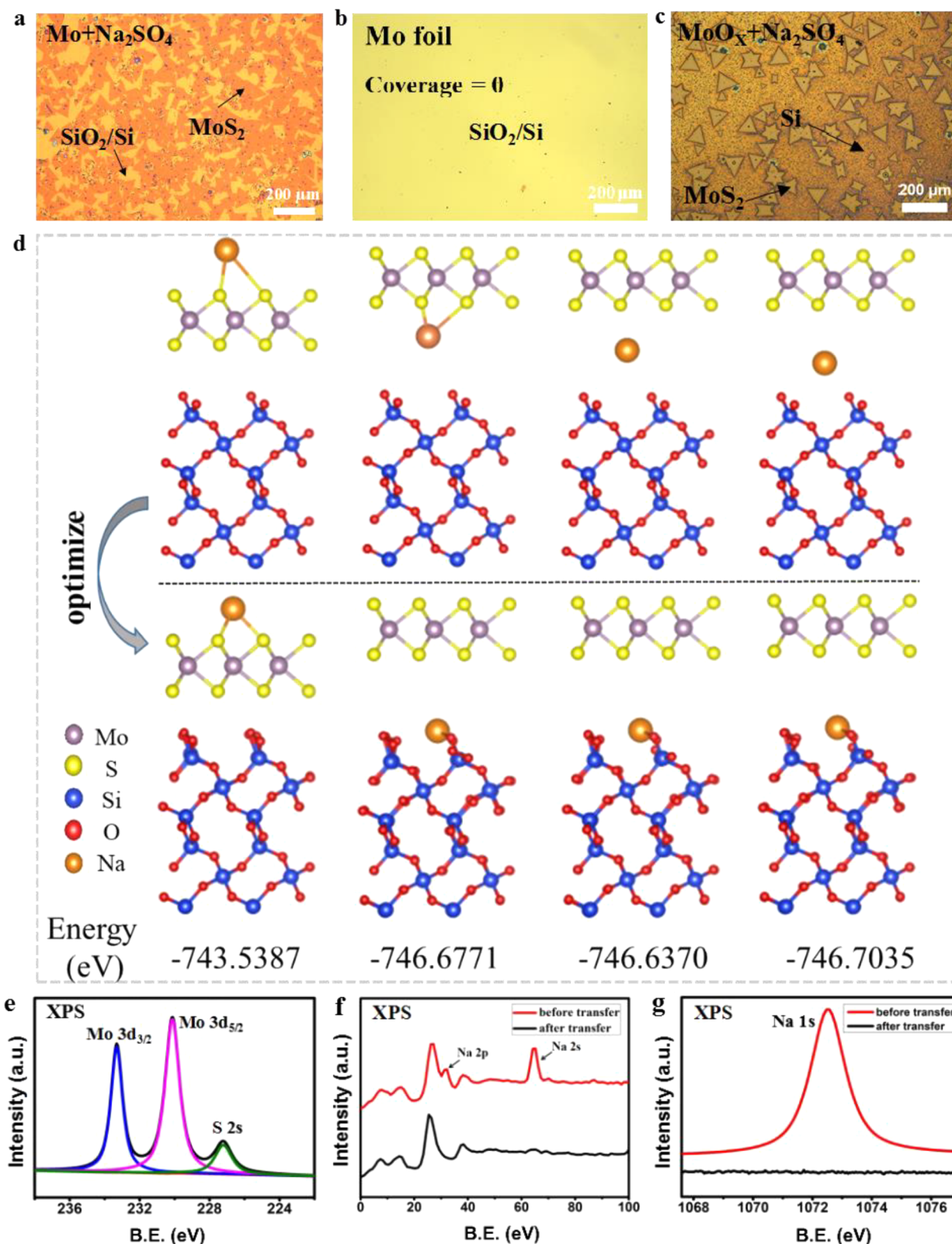


Figure 5. Synergistic growth mechanism of MoS₂. (a and b) Optical images of MoS₂ grown with Mo as precursor with (a, 0.05 mol/L) and without (b) Na₂SO₄ additive on SiO₂/Si substrate. (c) Optical image of MoS₂ grown with MoO_x as precursor with 0.05 mol/L Na₂SO₄ additive on Si substrate. (d) Original (top panel) and optimized (bottom panel) structures of monolayer MoS₂ on SiO₂ with an adsorbed Na atom. The corresponding total energy of each system is shown below the relaxed equilibrium geometry. (e) XPS data of Mo 3d, S 2s regions for MoS₂. (f and g) XPS data of Na 2p, Na 2s, and Na 1s for MoS₂ before and after transfer.

affect the growth quality of MoS₂, which had also been proved by TEM observations and electrical tests. Therefore, by

synergistically tuning the Mo source and Na catalysis, continuous and high-quality MoS₂ film can be achieved on

SiO₂/Si substrates, pushing 2D materials one step closer to real applications.

In summary, we demonstrated large-area growth of uniform and continuous MoS₂ film on SiO₂/Si substrates by synergistically mediating both precursor and catalyst during the CVD process. As-grown MoS₂ films exhibited good crystallinity, high-quality, and homogeneity, showing domain sizes as large as 632 μm and electron mobilities as high as 5.9 cm² V⁻¹ s⁻¹. Face-to-face MoO_x foil as precursor and Na₂SO₄ as promoter played critical roles in this growth method, and they did not affect the final quality of the MoS₂ film. This methodology can be further extended to grow other layered TMDs, paving a new road toward large-area production of layered TMDs for both fundamental research and industrial applications.

■ ASSOCIATED CONTENT

SI Supporting Information

The Supporting Information is available free of charge at <https://pubs.acs.org/doi/10.1021/acs.jpcllett.9b03879>.

Experimental details and figures including optical images of as-grown MoS₂, PL mappings, electrical data, and XPS data (PDF)

■ AUTHOR INFORMATION

Corresponding Authors

Zhenquan Tan – State Key Laboratory of Fine Chemicals, Panjin Branch of School of Chemical Engineering, Dalian University of Technology, Panjin 124221, Liaoning, China; orcid.org/0000-0002-1730-7290; Email: tanzq@dlut.edu.cn

Xue-Zhi Song – State Key Laboratory of Fine Chemicals, Panjin Branch of School of Chemical Engineering, Dalian University of Technology, Panjin 124221, Liaoning, China; orcid.org/0000-0001-9574-1570; Email: songxz@dlut.edu.cn

Nan Liu – Beijing Key Laboratory of Energy Conversion and Storage Materials, College of Chemistry, Beijing Normal University, Beijing 100875, China; orcid.org/0000-0002-1793-7372; Email: nanliu@bnu.edu.cn

Authors

Guanmeng Li – State Key Laboratory of Fine Chemicals, Panjin Branch of School of Chemical Engineering, Dalian University of Technology, Panjin 124221, Liaoning, China; Beijing Key Laboratory of Energy Conversion and Storage Materials, College of Chemistry, Beijing Normal University, Beijing 100875, China

Xiaoli Wang – College of Chemistry, Key Laboratory of Theoretical & Computational Photochemistry of Ministry of Education, Beijing Normal University, Beijing 100875, China

Bo Han – International Center for Quantum Materials and Electron Microscopy Laboratory, School of Physics, Peking University, Beijing 100871, China

Weifeng Zhang – Beijing Key Laboratory of Energy Conversion and Storage Materials, College of Chemistry, Beijing Normal University, Beijing 100875, China

Shuyan Qi – Beijing Key Laboratory of Energy Conversion and Storage Materials, College of Chemistry, Beijing Normal University, Beijing 100875, China

Yan Zhang – Beijing Key Laboratory of Energy Conversion and Storage Materials, College of Chemistry, Beijing Normal University, Beijing 100875, China

Jiakang Qiu – Beijing Key Laboratory of Energy Conversion and Storage Materials, College of Chemistry, Beijing Normal University, Beijing 100875, China

Peng Gao – International Center for Quantum Materials and Electron Microscopy Laboratory, School of Physics, Peking University, Beijing 100871, China; Collaborative Innovation Center of Quantum Matter, Beijing 100871, China; orcid.org/0000-0003-0860-5525

Shaoshi Guo – Beijing Key Laboratory of Energy Conversion and Storage Materials, College of Chemistry, Beijing Normal University, Beijing 100875, China

Run Long – College of Chemistry, Key Laboratory of Theoretical & Computational Photochemistry of Ministry of Education, Beijing Normal University, Beijing 100875, China; orcid.org/0000-0003-3912-8899

Complete contact information is available at: <https://pubs.acs.org/doi/10.1021/acs.jpcllett.9b03879>

Notes

The authors declare no competing financial interest.

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